

Tentative Specification
Preliminary Specification
Approval Specification

MODEL NO.: M170EGE SUFFIX: L20

Customer:	
APPROVED BY	SIGNATURE
Name / Title Note Product Version C2	
Please return 1 copy for y signature and comments.	your confirmation with your

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Version 2.0 22 March 2016 1 / 32



CONTENTS

1.	GENERAL DESCRIPTION	4
	1.1 OVERVIEW	
	1.2 GENERAL SPECIFICATIONS	4
2.	MECHANICAL SPECIFICATIONS	4
3.	ABSOLUTE MAXIMUM RATINGS	
	3.1 ABSOLUTE RATINGS OF ENVIRONMENT	5
	3.2 ELECTRICAL ABSOLUTE RATINGS	5
	3.2.1 TFT LCD MODULE	
	3.2.2 BACKLIGHT UNIT	
4.	ELECTRICAL SPECIFICATIONS	
	4.1 FUNCTION BLOCK DIAGRAM	
	4.2. INTERFACE CONNECTIONS	
	4.3 ELECTRICAL CHARACTERISTICS	
	4.3.1 LCD ELETRONICS SPECIFICATION	
	4.3.2 Vcc Power Dip Condition	
	4.3.3 BACKLIGHT UNIT	
	4.3.4 LIGHTBAR Connector Pin Assignment	
	4.4 LVDS INPUT SIGNAL SPECIFICATIONS	
	4.4.1 LVDS DATA MAPPING TABLE	
	4.4.2 COLOR DATA INPUT ASSIGNMENT	
	4.5 DISPLAY TIMING SPECIFICATIONS	
	4.6 POWER ON/OFF SEQUENCE	
5.	OPTICAL CHARACTERISTICS	
	5.1 TEST CONDITIONS	
	5.2 OPTICAL SPECIFICATIONS	
	RELIABILITY TEST ITEM	
7.	Mechanical Strength Characteristics	
	7.1 Mechanical Strength Specifications	
	7.2 Test Conditions	
_	7.3 Definition of Test Points	
8.	PACKING	
	8.1 PACKING SPECIFICATIONS	
	8.2 PACKING METHOD	
_	8.3 PALLET	
	INX MODULE LABEL	
10	D. PRECAUTIONS	
	10.1 ASSEMBLY AND HANDLING PRECAUTIONS	
	10.2 STORAGE PRECAUTIONS	
	10.3 OPERATION PRECAUTIONS	
	10.4 SAFETY PRECAUTIONS	
	10.5 SAFETY STANDARDS	
	10.6 OTHER	. 26
	opendix 1. SYSTEM COVER DESIGN NOTICE	
AI	pendix 2. OUTLINE DRAWING	. 30



REVISION HISTORY

Version	Date	Page	Description
2.0	2016-01-05		Spec Ver.2.0 was first issued.

Version 2.0 22 March 2016 3 / 32



1. GENERAL DESCRIPTION

1.1 OVERVIEW

M170EGE-L20 is a 17" TFT Liquid Crystal Display module with WLED Backlight unit and 30 pins 2ch-LVDS interface. This module supports 1280 \times 1024 SXGA mode and can display up to 16.7M colors. The converter module for Backlight is not built in.

1.2 GENERAL SPECIFICATIONS

Item	Specification	Unit	Note
Screen Size	17" real diagonal	-	-
Driver Element	a-si TFT active matrix	-	-
Pixel Number	1280 x R.G.B. x 1024,SXGA resolution	pixel	-
Pixel Pitch	0.264 (H) x 0.264 (V)	mm	-
Pixel Arrangement	RGB vertical stripe	-	-
Display Colors	16.7M	color	-
Transmissive Mode	Normally white	-	-
Surface Treatment	AG type, 3H hard coating, Haze 25	-	-
Luminance, White	250nits (Typ.)	Cd/m2	
Color Gamut	72% of NTSC(Typ.)	-	-
ROHS, Halogen Free &TCO 5.2	ROHS, Halogen Free, TCO 5.2 compliance		
Power Consumption	Total 10.8 W (Max.) @ cell 4.75 W (Max.), BL6.05	SW (Max.)	(1)

Note (1) The specified power consumption: Total= cell (reference 4.3.1)+BL (reference 4.3.3)

2. MECHANICAL SPECIFICATIONS

It	em	Min.	Тур.	Max.	Unit	Note	
	Horizontal (H)	358.0	358.5	359.0	mm		
Module Size	Vertical (V)	296.0	296.5	297.0	mm	(1)	
	Thickness (T)	-	10.5	11.0	mm		
Bezel Area	Horizontal	341.7	341.9	342.1	mm		
	Vertical	274.2	274.4	274.6	mm		
Active Area	Horizontal	-	337.92	-	mm		
	Vertical	-	270.336	-	mm		
Weight		-	1400	1500	g		

Note (1) Please refer to the attached drawings for more information of front and back outline dimensions.



3. ABSOLUTE MAXIMUM RATINGS

3.1 ABSOLUTE RATINGS OF ENVIRONMENT

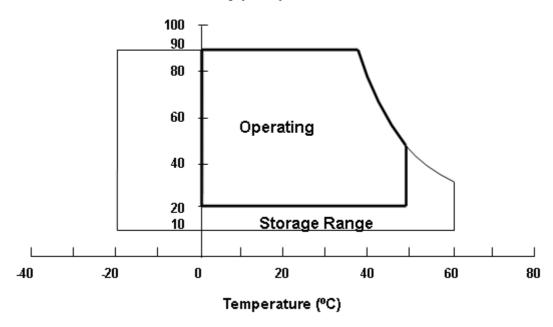
Item	Symbol	Va	Unit	Note		
item	Symbol	Min.	Max.	Offic	NOLE	
Storage Temperature	TST	-20	60	ºC	(1)	
Operating Ambient Temperature	TOP	0	50	ºC	(1), (2)	

Note (1)

- (a) 90 %RH Max. (Ta $<= 40 \, {}^{\circ}\text{C}$).
- (b) Wet-bulb temperature should be 39 °C Max. (Ta > 40 °C).
- (c) No condensation.

Note (2) Panel surface temperature should be 0° C min. and 65° C max under Vcc=5.0V, fr =60Hz, typical LED string current, 25° C ambient temperature, and no humidity control . Any condition of ambient operating temperature ,the surface of active area should be keeping not higher than 65° C.

Relative Humidity (%RH)



3.2 ELECTRICAL ABSOLUTE RATINGS

3.2.1 TFT LCD MODULE

Item	Symbol	Val	lue	Unit	Note
10111	Cymbol	Min.	Max.	Onit	11010
Power Supply Voltage	VCCS	-0.3	6.0	V	(1)
Logic Input Voltage	V _{IN}	-0.3	3.6	V	(1)

Version 2.0 22 March 2016 5 / 32



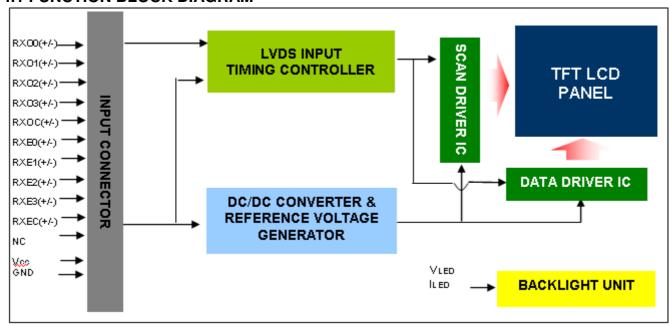
3.2.2 BACKLIGHT UNIT

Item	Symbol	Value			Unit	Note	
Item	Syllibol	Min. Typ		Max.	Oill	Note	
LED Forward Current Per Input Pin	I _F	0	40	44	mA	(1), (2) Duty=100%	
LED Pulse Forward Current Per Input Pin	l _P			150	mA	(1), (2) Pulse Width≦10msec. and Duty≦30%	

Note (1) Permanent damage to the device may occur if maximum values are exceeded. Function operation should be restricted to the conditions described under Normal Operating Conditions.

4. ELECTRICAL SPECIFICATIONS

4.1 FUNCTION BLOCK DIAGRAM



Version 2.0 22 March 2016 6 / 32

Note (2) Specified values are for input pin of LED light bar at Ta=25±2 °C (Refer to 4.3.3 and 4.3.4 for further information).



4.2. INTERFACE CONNECTIONS

PIN ASSIGNMENT

PIN ASSIGNMENT						
Pin	Name	Description				
1	RXO0-	Negative LVDS differential data input. Channel O0 (odd)				
2	RXO0+	Positive LVDS differential data input. Channel O0 (odd)				
3	RXO1-	Negative LVDS differential data input. Channel O1 (odd)				
4	RXO1+	Positive LVDS differential data input. Channel O1 (odd)				
5	RXO2-	Negative LVDS differential data input. Channel O2 (odd)				
6	RXO2+	Positive LVDS differential data input. Channel O2 (odd)				
7	GND	GND				
8	RXOC-	Negative LVDS differential clock input. (odd)				
9	RXOC+	Positive LVDS differential clock input. (odd)				
10	RXO3-	Negative LVDS differential data input. Channel O3(odd)				
11	RXO3+	Positive LVDS differential data input. Channel O3 (odd)				
12	RXE0-	Negative LVDS differential data input. Channel E0 (even)				
13	RXE0+	Positive LVDS differential data input. Channel E0 (even)				
14	GND	GND				
15	RXE1-	Negative LVDS differential data input. Channel E1 (even)				
16	RXE1+	Positive LVDS differential data input. Channel E1 (even)				
17	GND	GND				
18	RXE2-	Negative LVDS differential data input. Channel E2 (even)				
19	RXE2+	Positive LVDS differential data input. Channel E2 (even)				
20	RXEC-	Negative LVDS differential clock input. (even)				
21	RXEC+	Positive LVDS differential clock input. (even)				
22	RXE3-	Negative LVDS differential data input. Channel E3(even)				
23	RXE3+	Positive LVDS differential data input. Channel E3 (even)				
24	GND	GND				
25	NC	For LCD internal use only, Do not connect				
26	NC	For LCD internal use only, Do not connect				
27	NC	For LCD internal use only, Do not connect				
28	Vcc	+5.0V power supply				
29	Vcc	+5.0V power supply				
30	Vcc	+5.0V power supply				

Note (1) Connector Part No.: Foxconn:GS23301-0321R-7H or FCN:WF13-422-3033 or P-TWO:187098-30091.

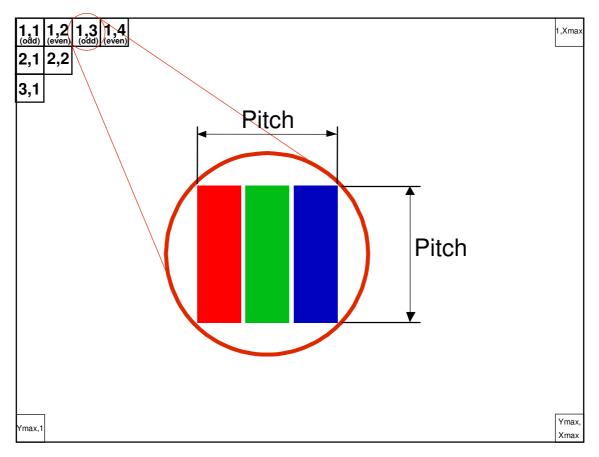
Note (2) User's connector Part No:

Mating Wire Cable Connector Part No.: FI-X30H(JAE) or FI-X30HL(JAE) Mating FFC Cable Connector Part No.: 217007-013001 (P-TWO) or JF05X030-1 (JAE).

Note (3) The first pixel is odd.

Note (4) Input signal of even and odd clock should be the same timing.





4.3 ELECTRICAL CHARACTERISTICS

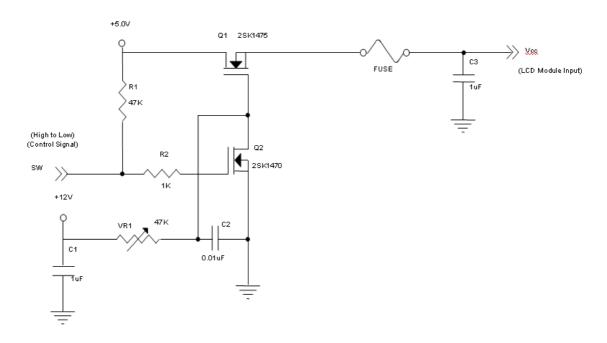
4.3.1 LCD ELETRONICS SPECIFICATION

Parameter		Symbol	Symbol Value			Unit	Note
		Syllibol	Min.	Тур.	Max.	Offic	Note
Power Supply	/ Voltage	Vcc	4.5	5	5.5	V	-
Ripple Vo	Itage	V_{RP}			300	mV	-
Rush Cu	rrent	I _{RUSH}			2	Α	(2)
	White			300	350	mA	(3)a
Power Supply Current	Black			890	950	mA	(3)b
	Vertical Stripe			800	850	mA	(3)c
Power Cons	umption	PLCD		4.45	4.75	Watt	(4)
LVDS differential	LVDS differential input voltage		100		600	mV	(5)
LVDS common input voltage		Vic	1.0	1.2	1.4	V	(5)
Logic High Input Voltage		VIH			100	mV	(5)
Logic Low Inpo	ut Voltage	VIL	-100			mV	(5)

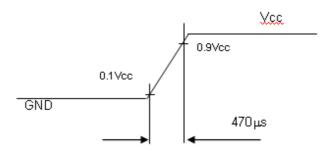
Note (1) The ambient temperature is $Ta = 25 \pm 2$ °C.

Note (2) Measurement Conditions:21



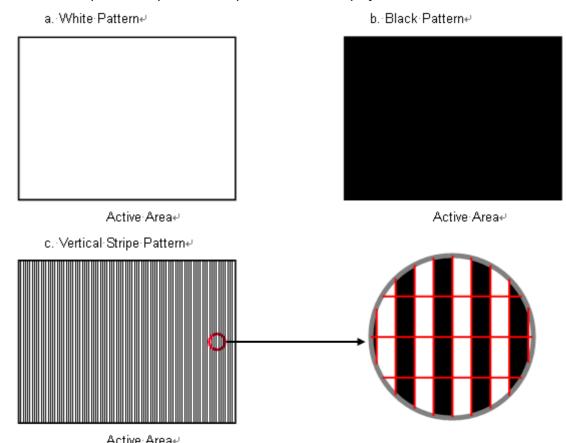


Vcc rising time is 470µs

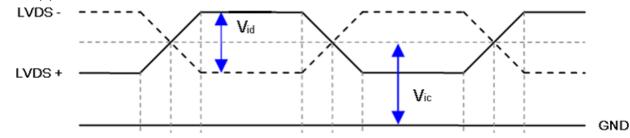




Note (3) The specified power supply current is under the conditions at Vcc = 5.0 V, $Ta = 25 \pm 2 \,^{\circ}\text{C}$, Fr = 75Hz, whereas a power dissipation check pattern below is displayed.



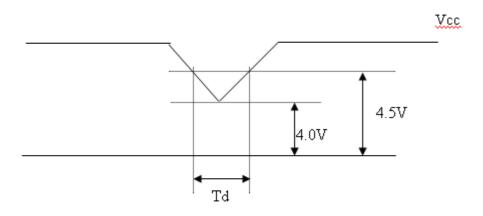
Note (4) The power consumption is specified at the pattern with the maximum current. Note (5) VID waveform condition



Version 2.0 22 March 2016 10 / 32



4.3.2 Vcc Power Dip Condition



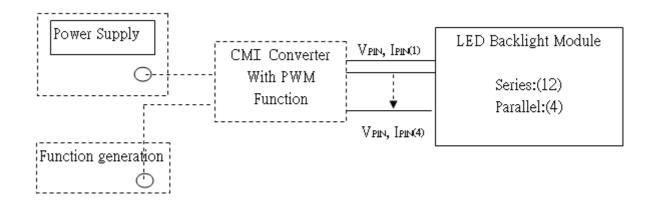
Dip condition:4.0 ≤ Vcc ≤ 4.5, Td ≤ 20ms

4.3.3 BACKLIGHT UNIT

Parameter	Symbol		Value		Unit	Note	
i arameter	Symbol	Min.	Тур.	Max.	Offic	Note	
LED Light Bar Input Voltage Per Input Pin	VPIN	34.2	36	37.8	V	(1), Duty=100%,	
LED Light Bar Current Per Input Pin	IPIN	37.6	40	42.4	mA	(1), (2) Duty=100%	
LED Life Time	LLED	50000			Hrs	(3)	
LED Light Bar Power Consumption	PBL		5.76	6.05	W	(1) Duty=100%,	

Note (1) LED light bar input voltage and current are measured by utilizing a true RMS multimeter as shown below:

- Note (2) PBL= IPIN× VPIN× (4) PBL.
- Note (3) The lifetime of LED is defined as the time when LED packages continue to operate under the conditions at Ta = 25 ± 2 °C and I= (65)mA (per chip) until the brightness becomes \leq 50% of its original value.
- Note (4) The module must be operated with constant driving current.

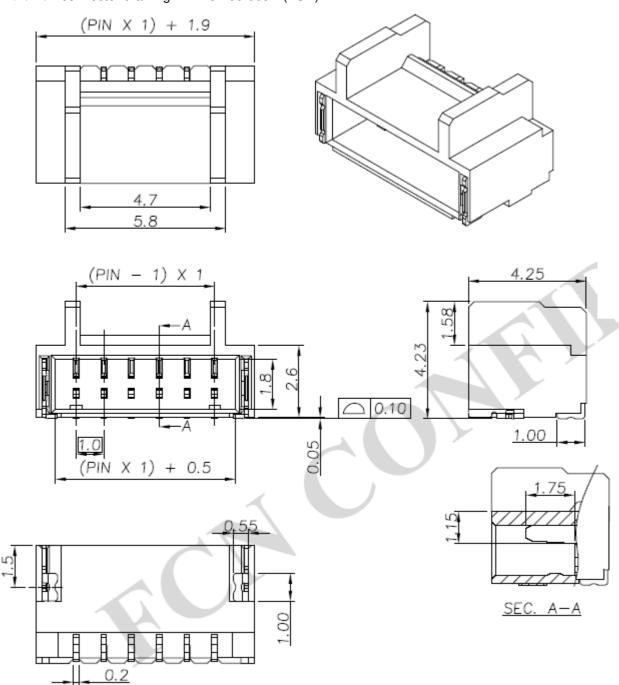


Version 2.0 22 March 2016 11 / 32



4.3.4 LIGHTBAR Connector Pin Assignment

- (1) Connector(wire type):FCN(WM13-406-063N) or Entery(3707K-Q06N-08L) or CviLux(CI1406M1HRK-NH).
- (2) L/B connector drawing. WM13-406-063N (FCN)



Other equivalents please refer to individual drawing

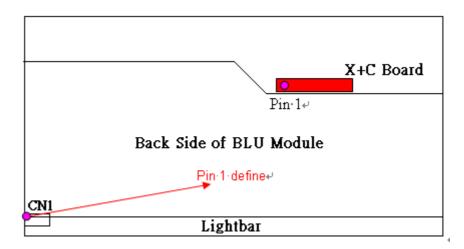


CN1

Pin	Description
number	
1	Cathode of LED string
2	Cathode of LED string
3	VLED
4	VLED
5	Cathode of LED string
6	Cathode of LED string

Note (1) User's Mating Connector Part No.:

FCN(WF1300106-B) or Entery(H112K-P06N-01B or M001-E11N-00R) or CviLux(CI1406SL000-NH) and hook width must be less than 4.5mm.



4.4 LVDS INPUT SIGNAL SPECIFICATIONS

4.4.1 LVDS DATA MAPPING TABLE

LVDS Channel O0	LVDS output	D7	D6	D4	D3	D2	D1	D0
LVD3 Charmer 00	Data order	OG0	OR5	OR4	OR3	OR2	OR1	OR0
LVDS Channel O1	LVDS output	D18	D15	D14	D13	D12	D9	D8
LVD3 Ghanner O1	Data order	OB1	OB0	OG5	OG4	OG3	OG2	OG1
LVDS Channel O2	LVDS output	D26	D25	D24	D22	D21	D20	D19
LVD3 Ghanner 02	Data order	DE	NA	NA	OB5	OB4	OB3	OB2
LVDS Channel O3	LVDS output	D23	D17	D16	D11	D10	D5	D27
LVD3 Ghanner O3	Data order	NA	OB7	OB6	OG7	OG6	OR7	OR6
LVDS Channel E0	LVDS output	D7	D6	D4	D3	D2	D1	D0
LVD3 Charmer L0	Data order	EG0	ER5	ER4	ER3	ER2	ER1	ER0
LVDS Channel E1	LVDS output	D18	D15	D14	D13	D12	D9	D8
LVD3 Channel E1	Data order	EB1	EB0	EG5	EG4	EG3	EG2	EG1
LVDS Channel E2	LVDS output	D26	D25	D24	D22	D21	D20	D19
LVD3 GHallilei E2	Data order	DE	NA	NA	EB5	EB4	EB3	EB2
LVDS Channel E3	LVDS output	D23	D17	D16	D11	D10	D5	D27
LVD3 GHAHHEI E3	Data order	NA	EB7	EB6	EG7	EG6	ER7	ER6



4.4.2 COLOR DATA INPUT ASSIGNMENT

The brightness of each primary color (red, green and blue) is based on the 8-bit gray scale data input for the color. The higher the binary input, the brighter the color. The table below provides the assignment of color versus data input.

VOIDGO	data input.											Da	ata	Sigr	nal										
	Color				Re	ed								reer	า						Blı	Je			
		R7	R6	R5	R4	R3	R2	R1	R0	G 7	G 6	G 5	G 4	G3	G2	G1	G0	B 7	B6	B5	B4	ВЗ	B2	В 1	B 0
	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
l	Green	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
Basic	Blue	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
Colors	Cyan	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Magenta	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
	Yellow	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Red(0) / Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(1)	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Gray	Red(2)	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Scale	;	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
Of	_ :	:	:	:	:	:		:	_	:		:	_	:	:	:			:	_	:	:	:	:	
Red	Red(253)	1	1	1	1	1	1	0	1	0	0	0	:0	0	0	0	0	0	0	0	0	0	0	0	:0
1100	Red(254)	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(255)	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green(0) / Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green(1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0
Gray	Green(2)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0
Scale	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
Of	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
Green	Green(253)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	0	1	0	0	0	0	0	0	0	0
	Green(254)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0
	Green(255)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	Blue(0) / Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Blue(1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
Gray	Blue(2)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0
Scale	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
Of	: DI - (050)	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	;	:	;	:	:	:	; [
Blue	Blue(253)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	0	1
	Blue(254)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	0
	Blue(255)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1

Note (1) 0: Low Level Voltage, 1: High Level Voltage





4.5 DISPLAY TIMING SPECIFICATIONS

The input signal timing specifications are shown as the following table and timing diagram.

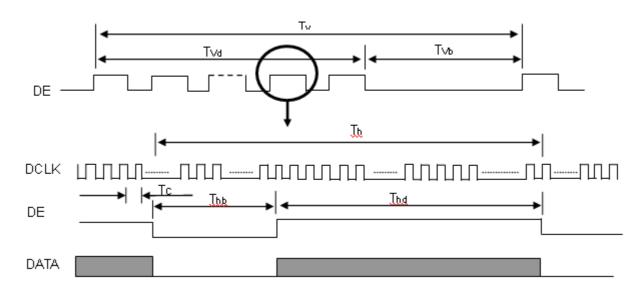
Signal	Item	Symbol	Min.	Тур.	Max.	Unit	Note
	Frequency	Fc	45	54	69.3	MHz	-
	Period	Tc	14.43	18.52	22.22	ns	
	Input cycle to cycle jitter	T _{rcl}	-0.02*TC		0.02*TC	ns	(1)
	Input Clock to data skew	TLVCCS	-0.02*TC		0.02*TC	ns	(2)
LVDS Clock	Spread spectrum modulation range	Fclkin_ mod	0.97*FC		1.03*FC	MHz	(2)
	Spread spectrum modulation frequency	F_{SSM}			100	KHz	(3)
	Frame Rate	Fr	50	60	75	Hz	
Vertical Display Term	Total	Tv	1044	1066	1450	Th	Tv=Tvd+Tvb (1)-
vertical display fertil	Active Display	Tvd		1024		Th	-
	Blank	Tvb	20	42		Th	-
	Total	Th	790	844	880	Tc	Th=Thd+Thb
Horizontal Display Term	Active Display	Thd		640		Тс	-
	Blank	Thb	150	204		Tc	-

Note: Because this module is operated by DE only mode, Hsync and Vsync input signals are ignored.

(1)Please make sure the range of pixel clock has follow below equation:

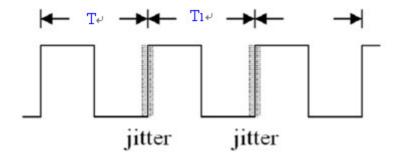
 $Fc(max) \ge FrxTvxTh$ $FrxTvxTh \ge Fc(min)$

INPUT SIGNAL TIMING DIAGRAM

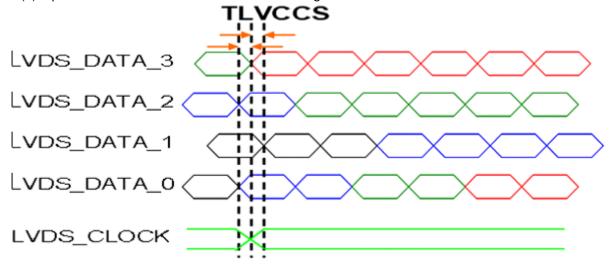




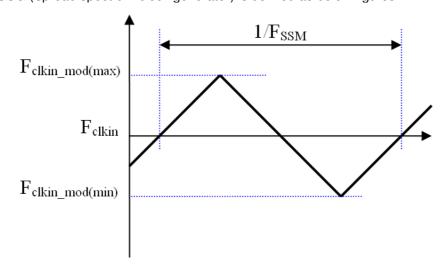
Note (1) The input clock cycle-to-cycle jitter is defined as below figures. Trcl = $IT_1 - TI$



Note (2) Input Clock to data skew is defined as below figures.



Note (3) The SSCG (Spread spectrum clock generator) is defined as below figures.

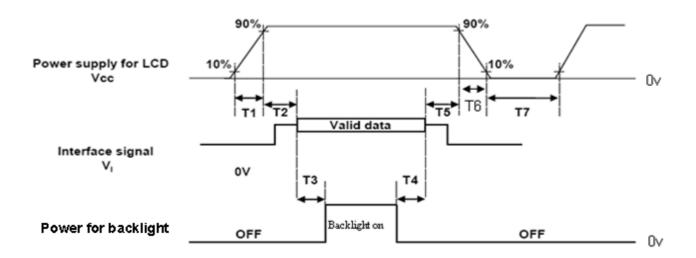


Version 2.0 22 March 2016 16 / 32



4.6 POWER ON/OFF SEQUENCE

The power sequence specifications are shown as the following table and diagram.



Timing Specifications:

Tirring epecinications:								
Parameters		Values						
Tarameters	Min	Тур.	Max	Units				
T1	0.5	-	10	ms				
T2	0	30	50	ms				
T3	200	250	-	ms				
T4	100	250	-	ms				
T5	-	20	50	ms				
T6	0.1	-	100	ms				
T7	1000	-	-	ms				

- Note (1) The supply voltage of the external system for the module input should be the same as the definition of Vcc.
- Note (2) When the backlight turns on before the LCD operation of the LCD turns off, the display may momentarily become abnormal screen.
- Note (3) In case of VCC = off level, please keep the level of input signals on the low or keep a high impedance.
- Note (4) T7 should be measured after the module has been fully discharged between power off and on period.
- Note (5) Interface signal shall not be kept at high impedance when the power is on.
- Note (6) CMI won't take any responsibility for the products which are damaged by the customers not following the Power Sequence.
- Note (7) There might be slight electronic noise when LCD is turned off (even backlight unit is also off). To avoid this symptom, we suggest "Vcc falling timing" to follow "t6 spec".



5. OPTICAL CHARACTERISTICS

5.1 TEST CONDITIONS

Item	Symbol	Value	Unit		
Ambient Temperature	Ta	25±2	°C		
Ambient Humidity	На	50±10	%RH		
Supply Voltage	V _{CC}	5	V		
Input Signal	According to typical value in "3. ELECTRICAL CHARACTERISTICS"				
LED Light Bar Input Current Per Input Pin	I _{PIN}	40±2.4	mA _{DC}		
PWM Duty Ratio	D	100	%		
LED Light Bar Test Converter	TEST01001 T2-D1				

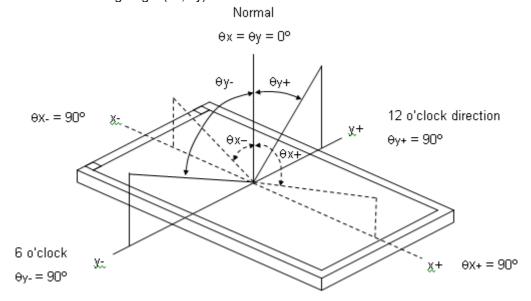
5.2 OPTICAL SPECIFICATIONS

The relative measurement methods of optical characteristics are shown in 5.2. The following items should be measured under the test conditions described in 5.1 and stable environment shown in Note (5).

Iter	n	Symbol	Condition	Min.	Тур.	Max.	Unit	Note
	Dod	Rx			0.635			
	Red	Ry			0.340			
	Green	Gx		Typ - 0.03	0.312			
Color Chromaticity	Green	Gy			0.626	Тур +		(1) (5)
(CIE 1931)	Blue	Bx	$\theta_x=0^\circ, \ \theta_Y=0^\circ$		0.158	0.03		(1), (5)
(3.2 1331)	Diue	Ву	CS-2000 R=G=B=255		0.058			
	White	Wx	Gray scale		0.313			
		Wy	,		0.329			
	Center Luminance of White (Center of Screen)			200	250	-	cd/m ²	(4), (5)
Contrast	Ratio	CR		700	1000	-	-	(2), (5)
Respons	e Time	T_R	$\theta_x=0^\circ, \ \theta_Y=0^\circ$	-	1	4	ms	(3)
Пезропз	C Tillic	T _F		-	4	6	1113	(0)
White Va	riation	W	$\theta_x = 0^\circ, \ \theta_Y = 0^\circ$	75	80		%	(5), (6)
Viewing Angle	Horizontal	$\theta x - + \theta x +$	CR ≥ 10	150	170	-	Deg.	(1), (5)
Viewing Angle	Vertical	θ y- + θ y+		140	160	-	Deg.	(1), (3)
Viewing Angle	Horizontal	$\theta x - + \theta x +$	$CR \geq 5$	160	178		Deg.	(1), (5)
Vicwing Angle	Vertical	$\theta y - + \theta y +$		150	170		Dog.	(1), (3)



Note (1) Definition of Viewing Angle $(\theta x, \theta y)$:



Note (2) Definition of Contrast Ratio (CR):

The contrast ratio can be calculated by the following expression.

Contrast Ratio (CR) = L255 / L0

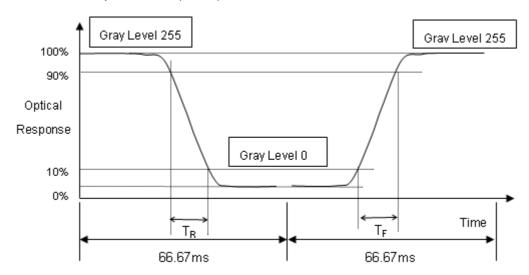
L255: Luminance of gray level 255

L 0: Luminance of gray level 0

CR = CR(5)

CR (X) is corresponding to the Contrast Ratio of the point X at Figure in Note (6).

Note (3) Definition of Response Time (T_R, T_F):





Note (4) Definition of Luminance of White (L_C):

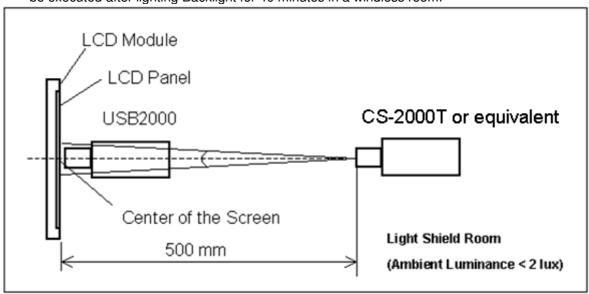
Measure the luminance of gray level 255 at center point

 $L_{C} = L(5)$

L(x) is corresponding to the luminance of the point X at Figure in Note (6).

Note (5) Measurement Setup:

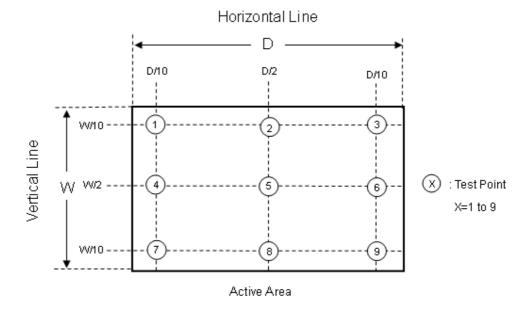
The LCD module should be stabilized at given temperature for 40 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 40 minutes in a windless room.



Note (6) Definition of White Variation (δW):

Measure the luminance of gray level 255 at 9 points

 $\delta W = (Minimum [L (1) \sim L (9)] / Maximum [L (1) \sim L (9)]) *100%$





6. RELIABILITY TEST ITEM

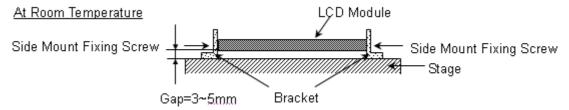
Items	Required Condition	Note
Temperature Humidity Bias (THB)	Ta= 50°C , 80%RH, 240hours	
High Temperature Operation (HTO)	Ta= 50°C , 240hours	
Low Temperature Operation (LTO)	Ta= 0°C , 240hours	
High Temperature Storage (HTS)	Ta= 60° C , 240hours	
Low Temperature Storage (LTS)	Ta= -20 $^{\circ}$ C , 240hours	
Vibration Test (Non-operation)	Acceleration: 1.5 G Wave: Half-sine Frequency: 10 - 300 Hz Sweep: 30 Minutes each Axis (X, Y, Z)	
Ohaali Tast	Acceleration: 50 G Wave: Half-sine Active Time: 11 ms	
Shock Test (Non-operation)	Direction : $\pm X$, $\pm Y$, $\pm Z$.(one time for each Axis)	
Thermal Shock Test (TST)	-20°C/30min , 60°C / 30min , 100 cycles	
On/Off Test	25℃ ,On/10sec , Off /10sec , 30,000 cycles	
ESD (Electro Static Discharge)	Contact Discharge: ± 8KV, 150pF(330Ω)	
	Air Discharge: ± 15KV, 150pF(330Ω) Operation:16,404 ft / 24hours	
Altitude Test	Non-Operation:30,000 ft / 24hours	

Note (1) criteria: Normal display image with no obvious non-uniformity and no line defect.

Note (2) Evaluation should be tested after storage at room temperature for more than two hour

Note (3) At testing Vibration and Shock, the fixture in holding the module has to be hard and rigid enough so that the module would not be twisted or bent by the fixture.

The fixing condition is shown as below:





7. Mechanical Strength Characteristics

7.1 Mechanical Strength Specifications

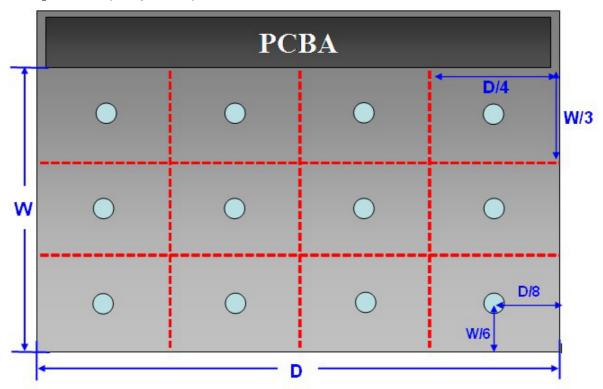
Item	Condition	Min	Unit	Note
Mechanical Strength	128 th Gray Pattern	0.6	Kgf	

7.2 Test Conditions

Items	Description
Test Condition	 Ambient Illumination: 10~15 lux Test Pattern: 128 Gray Distance of the judgment: 30cm from the surface of module Viewing angle of the judgment: Front
Gage Information	1. Push pull guage a. Model name: HF-50, maker: ALGOL b. Shape of gage tip - Diameter: 2mm - Thickness: 2mm
Definition of Minimum force	To measure minimum force when operator detects any white spot and light leakage that have occurred while operator presses on back side of module with push pull gage.

7.3 Definition of Test Points

Measure the minimum force of test points at 128th Gray pattern. The test points at back side of module area is showing as below (except PCBA).





8. PACKING

8.1 PACKING SPECIFICATIONS

- (1) 12 LCD modules / 1 Box
- (2) Box dimensions:450(L) X 340 (W) X 369(H) mm
- (3) Weight: approximately: 17.91kg (12 modules per box)

8.2 PACKING METHOD

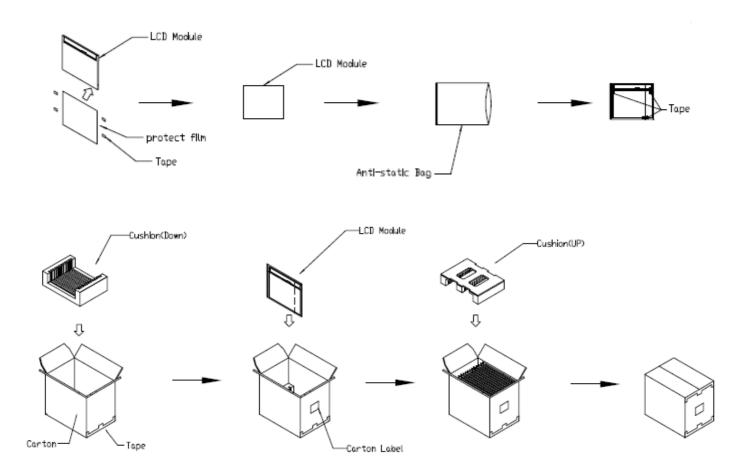
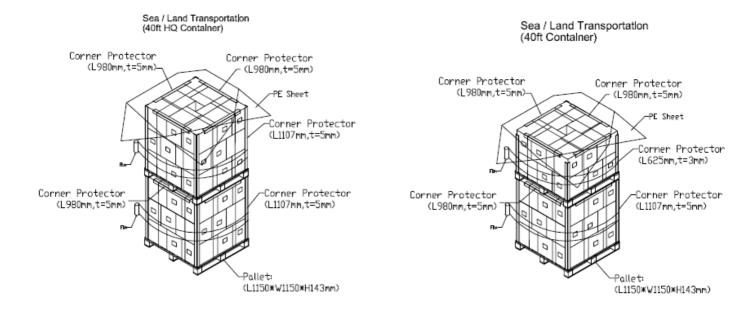


Figure. 7-1 Packing method



8.3 PALLET



Air Transportation

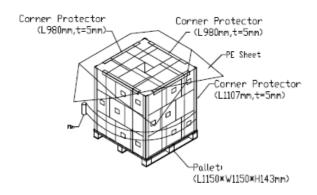


Figure. 7-2 Packing method



9. INX MODULE LABEL

The barcode nameplate is pasted on each module as illustration, and its definitions are as following explanation.



- (a) Model Name: M170EGE-L20
- (b) Revision: Rev. XX, for example: A0, A1... B1, B2... or C1, C2...etc.
- (c) CMI barcode definition:

Serial ID: XX-XX-X-XX-YMD-L-NNNN

Code	Meaning	Description
XX	INX internal use	-
XX	Revision	Cover all the change
Х	INX internal use	-
XX	INX internal use	-
YMD	Year, month, day	Year: 2001=1, 2002=2, 2003=3, 2004=4 Month: 1~12=1, 2, 3, ~, 9, A, B, C Day: 1~31=1, 2, 3, ~, 9, A, B, C, ~, W, X, Y, exclude I, O, and U.
L	Product line #	Line 1=1, Line 2=2, Line 3=3,
NNNN	Serial number	Manufacturing sequence of product

(d) Customer's barcode definition:

Serial ID: CM-H0E20-X-X-X-XX-L-XX-L-YMD-NNNN

Code	Meaning	Description
CM	Supplier code	INX =CM
H0E20	Model number	M170EGE-L20= H0E20
Х	Revision code	Non ZBD: 1,2,~,8,9 / ZBD: A~Z
Х	Source driver IC code	filiachi=7, flyfiix=6, LDi=9, Malsushila=A, NEC=B, Novalec=C, OKi=D,
Х	Gate driver IC code	Philips=E, Renasas=F, Samsung=G, Sanyo=H, Sharp=I, TI=J, Topro=K, Toshiba=L, Windbond=M, ILITEK=Q, Fiti=Y, None IC =Z
XX	Cell location	Tainan Taiwan=TN, Ningbo China=CN, Hsinchu Taiwan=SC
L	Cell line #	1,2,~,9,A,B,~,Y,Z
XX	Module location	Tainan, Taiwan=TN ; Ningbo China=NP, Shenzhen China=SH
L	Module line #	1,2,~,9,A,B,~,Y,Z
YMD	Year, month, day	Year: 0~9, 2001=1, 2002=2, 2003=32010=0, 2011=1, 2012=2 Month: 1~12=1, 2, 3, ~, 9, A, B, C Day: 1~31=1, 2, 3, ~, 9, A, B, C, ~, T, U, V
NNNN	Serial number	By LCD supplier

(e) Addition of Customer's M/N and version, for example: CP677120-01 01A



(e) FAB ID (UL Factory ID):

Region₽	Factory ID4	ته
TWINX₽	GEMN₽	ته
NBCM⊮	LE00₽	ته
NBCMI₽	VIRO₽	Ç
NBCME₽	CANO₽	ته
NHCM⊮	CAPG₽	ته

10. PRECAUTIONS

10.1 ASSEMBLY AND HANDLING PRECAUTIONS

- (1) Do not apply rough force such as bending or twisting to the module during assembly.
- (2) To assemble or install module into user's system can be only in clean working areas. The dust and oil may cause electrical short or worsen the polarizer.
- (3) It's not permitted to have pressure or impulse on the module because the LCD panel and Backlight will be damaged.
- (4) Always follow the correct power sequence when LCD module is connecting and operating. This can prevent damage to the CMOS LSI chips during latch-up.
- (5) Do not pull the I/F connector in or out while the module is operating.
- (6) Do not disassemble the module.
- (7) Use a soft dry cloth without chemicals for cleaning, because the surface of polarizer is very soft and easily scratched.
- (8) It is dangerous that moisture come into or contacted the LCD module, because moisture may damage LCD module when it is operating.
- (9) High temperature or humidity may reduce the performance of module. Please store LCD module within the specified storage conditions.
- (10)When ambient temperature is lower than 10°C may reduce the display quality. For example, the response time will become slowly.

10.2 STORAGE PRECAUTIONS

- (1) Do not leave the module in high temperature, and high humidity for a long time. It is highly recommended to store the module with temperature from 0° C to 35° C and relative humidity of less than 70%
- (2) Do not store the TFT LCD module in direct sunlight
- (3) The module should be stored in dark place. It is prohibited to apply sunlight or fluorescent light in storing

10.3 OPERATION PRECAUTIONS

(1) The LCD product should be operated under normal condition.

Normal condition is defined as below:

Temperature : 20±15°C Humidity: 65±20%

Display pattern: continually changing pattern(Not stationary)

(2) If the product will be used in extreme conditions such as high temperature, high humidity, high altitude, display pattern or operation time etc...It is strongly recommended to contact CMI for application engineering advice. Otherwise, Its reliability and function may not be guaranteed.

10.4 SAFETY PRECAUTIONS

- (1) If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth. In case of contact with hands, skin or clothes, it has to be washed away thoroughly with soap.
- (2) After the module's end of life, it is not harmful in case of normal operation and storage.

10.5 SAFETY STANDARDS

The LCD module should be certified with safety regulations as follows:

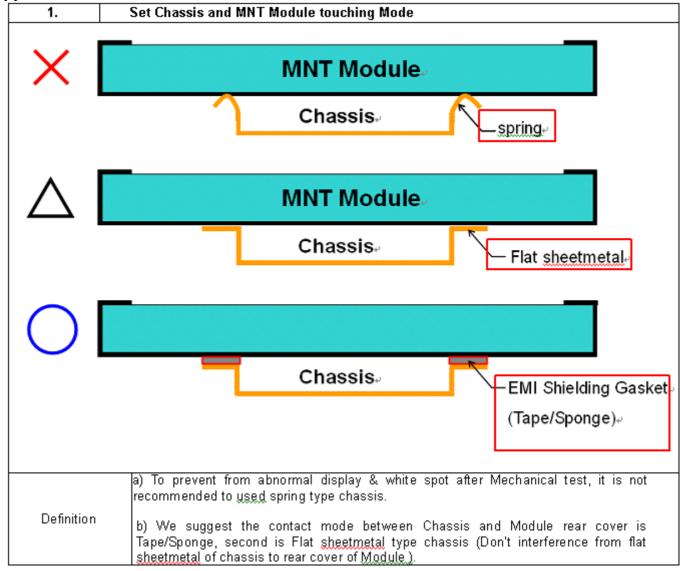
- (1) UL60950-1 or updated standard.
- (2) IEC60950-1 or updated standard.

10.6 OTHER

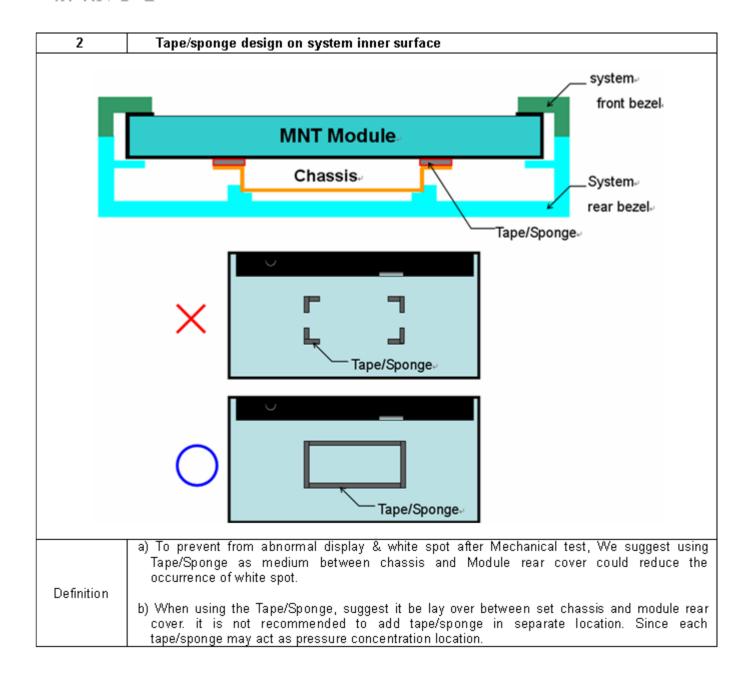
When fixed patterns are displayed for a long time, remnant image is likely to occur.



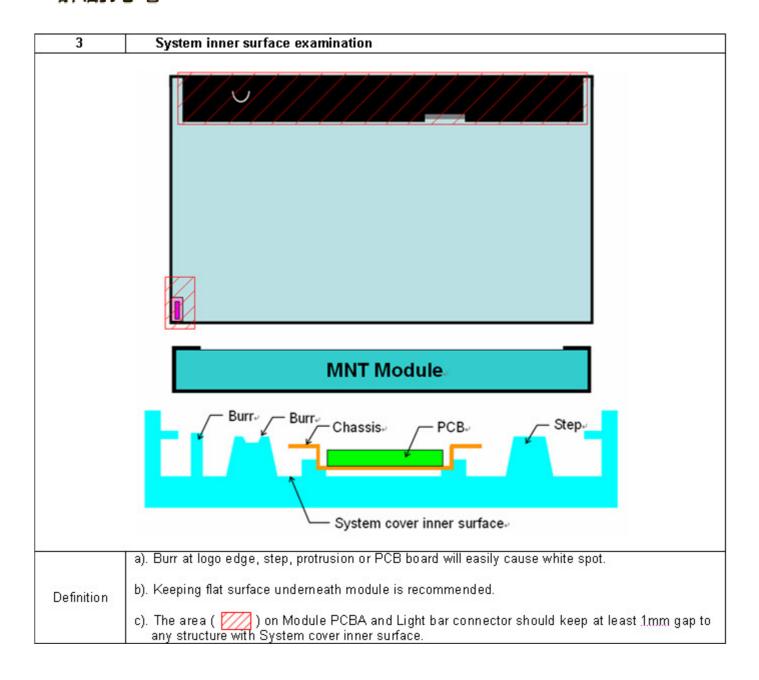
Appendix 1. SYSTEM COVER DESIGN NOTICE



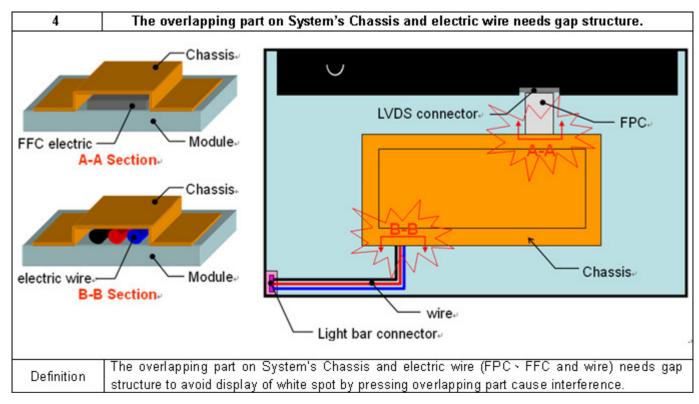


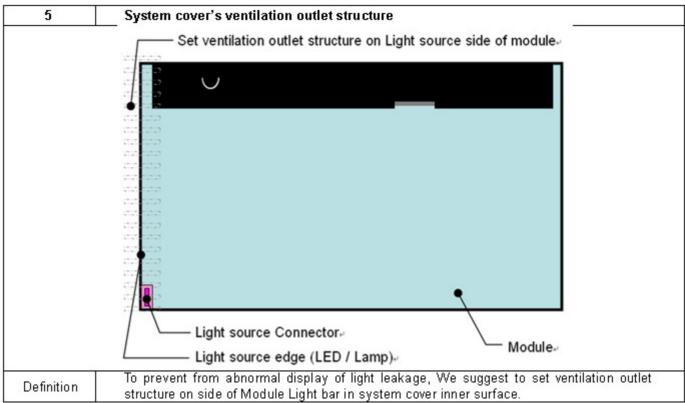












Appendix 2. OUTLINE DRAWING

Version 2.0 22 March 2016 30 / 32